

L Number	Hits	Search Text	DB	Time stamp
1	731	(ball\$2 near pad\$s) and (chip or die)	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2003/01/14 13:07
2	8	((ball\$2 near pad\$s) and (chip or die)) and ((shape or v or x) near pad)	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2003/01/14 13:07
3	2549	((shape or v or x) near pad)	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2003/01/14 13:08
4	3	((shape or v or x) near pad)) and ((solder adj ball\$2) near pad\$s)	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2003/01/14 13:08
5	117	((shape or configur\$4) near pad\$2) and (solder adj ball\$2)	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2003/01/14 13:10
6	80	((shape or configur\$4) near pad\$2) and (solder adj ball\$2)) and (@ad<20010213)	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2003/01/14 13:11